Product Description

Curing type	Heating to cure
Usage	Electronic products
Best advantage	Quality&Price&Brand
Curing temperature	70°Cx30min,93°Cx15min,121°Cx5min
Price	Wholesale price
Production type	ODM/OEM



Product Usage



MODEL	BST-559A
BRAND	BEST
PRODUCT NAME	Insulation solder paste
WEIGHT	100g
TYPE	Strong activity,less residue easy to tin

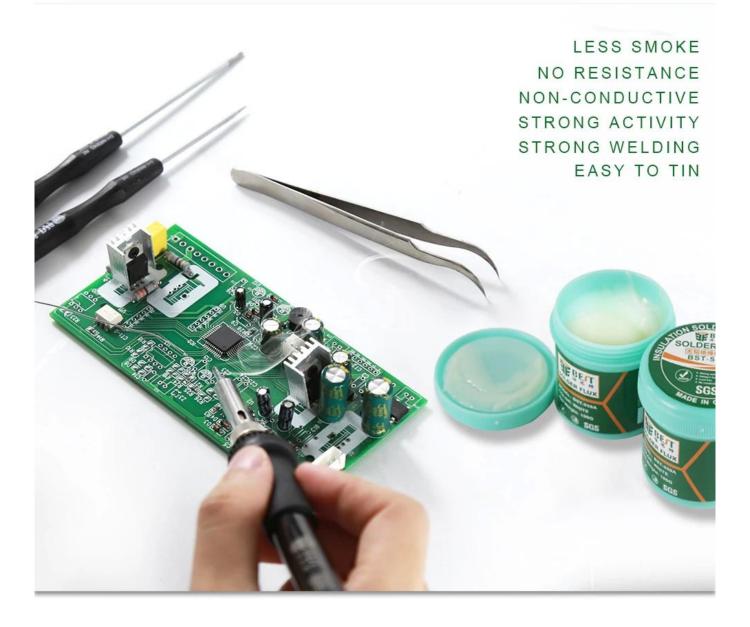
▼ characteristics

This product is widely used in PCB, BGA, CSP and welding repair It is low halogen, can reach industry standards With oxide layer for rapid removal of metal-surfaces, components and Strong metal bonding performance, Non-conductive insulation, fast wetting, less smoke, less residue

PRODUCT INFORMATION

Welding requirements for a wide range of products





PRODUCT SIZE



T5MM

T5MM

T5MM

T5MM

T5MM

T5MM

T5MM

62.5MM 52N